

# DATA SHEET

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## **74HC3G06; 74HCT3G06**

**Inverter with open-drain outputs**

Product specification  
Supersedes data of 2003 May 15

2003 Dec 02

## Inverter with open-drain outputs

## 74HC3G06; 74HCT3G06

## FEATURES

- Wide supply voltage range from 2.0 to 6.0 V
- High noise immunity
- Low power dissipation
- SOT505-2 and SOT765-1 package
- ESD protection:  
HBM EIA/JESD22-A114-A exceeds 2000 V  
MM EIA/JESD22-A115-A exceeds 200 V.
- Specified from  $-40$  to  $+85$  °C and  $-40$  to  $+125$  °C.

## DESCRIPTION

The 74HC3G06/74HCT3G06 is a high-speed Si-gate CMOS device. Specified in compliance with JEDEC standard no. 7A.

The 74HC3G06/74HCT3G06 provides three inverting buffers.

The outputs of the 74HC3G06; 74HCT3G06 devices are open drains and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions. For digital operation this device must have a pull-up resistor to establish a logic HIGH-level.

## QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25$  °C;  $t_r = t_f \leq 6.0$  ns.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC3G	HCT3G	
$t_{pZL}$	propagation delay nA to nY	$C_L = 50$ pF; $V_{CC} = 4.5$ V	9	9	ns
$t_{PLZ}$	propagation delay nA to nY	$C_L = 50$ pF; $V_{CC} = 4.5$ V	11	12	ns
$C_I$	input capacitance		1.5	1.5	pF
$C_{PD}$	power dissipation capacitance per buffer	notes 1 and 2	4	4	pF

## Notes

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in Volts;

$N$  = total load switching outputs;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

2. For 74HC3G06 the condition is  $V_I = \text{GND}$  to  $V_{CC}$ .  
For 74HCT3G06 the condition is  $V_I = \text{GND}$  to  $V_{CC} - 1.5$  V.

## Inverter with open-drain outputs

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**FUNCTION TABLE**

See note 1.

INPUT	OUTPUT
nA	nY
L	Z
H	L

**Note**

1. H = HIGH voltage level;  
L = LOW voltage level;  
Z = high-impedance OFF-state.

**ORDERING INFORMATION**

TYPE NUMBER	PACKAGE					
	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE	MARKING
74HC3G06DP	-40 to +125 °C	8	TSSOP8	plastic	SOT505-2	H06
74HCT3G06DP	-40 to +125 °C	8	TSSOP8	plastic	SOT505-2	T06
74HC3G06DC	-40 to +125 °C	8	VSSOP8	plastic	SOT765-1	H06
74HCT3G06DC	-40 to +125 °C	8	VSSOP8	plastic	SOT765-1	T06

**PINNING**

PIN	SYMBOL	DESCRIPTION
1	1A	data input
2	3Y	data output
3	2A	data input
4	GND	ground (0 V)
5	2Y	data output
6	3A	data input
7	1Y	data output
8	V <sub>CC</sub>	supply voltage

# Inverter with open-drain outputs

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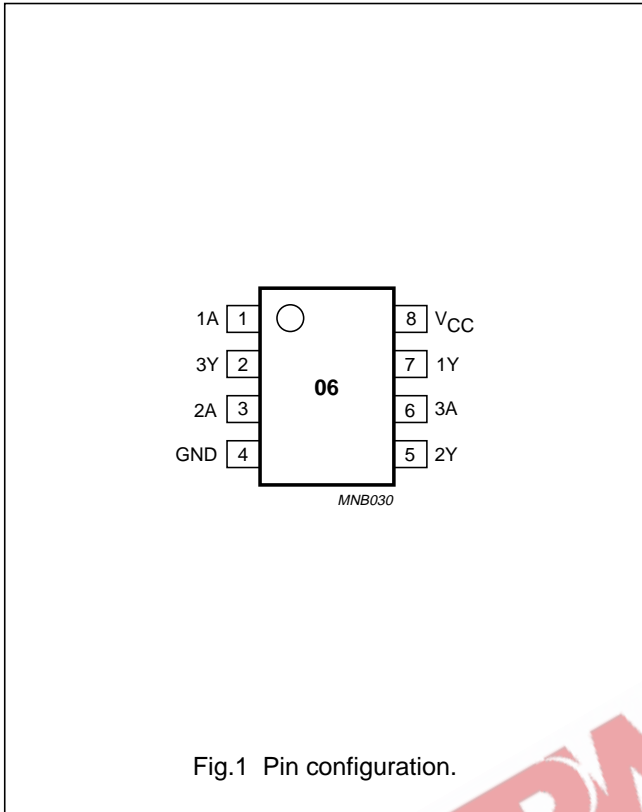


Fig.1 Pin configuration.

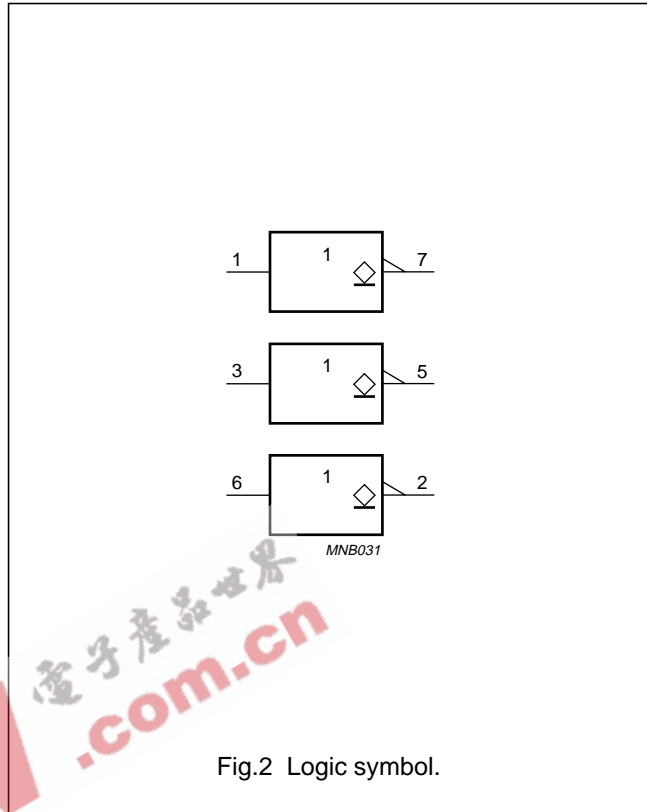


Fig.2 Logic symbol.

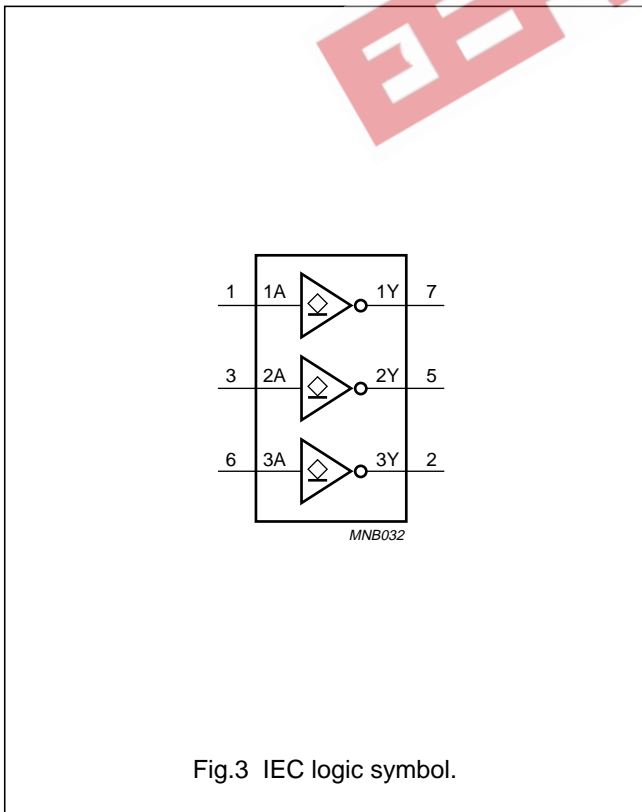


Fig.3 IEC logic symbol.

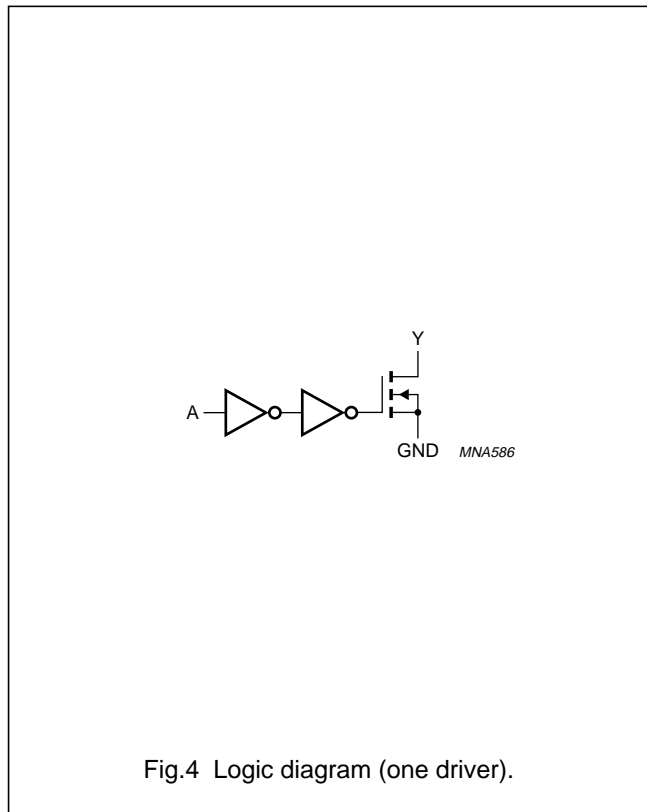


Fig.4 Logic diagram (one driver).

## Inverter with open-drain outputs

## 74HC3G06; 74HCT3G06

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	74HC3G06			74HCT3G06			UNIT
			MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
$V_{CC}$	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
$V_I$	input voltage		0	–	6.0	0	–	5.5	V
$V_O$	output voltage		0	–	$V_{CC}$	0	–	$V_{CC}$	V
$T_{amb}$	operating ambient temperature	see DC and AC characteristics per device	–40	+25	+125	–40	+25	+125	°C
$t_r, t_f$	input rise and fall times	$V_{CC} = 2.0$ V	–	–	1000	–	–	–	ns
		$V_{CC} = 4.5$ V	–	6.0	500	–	6.0	500	ns
		$V_{CC} = 6.0$ V	–	–	400	–	–	–	ns

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CC}$	supply voltage		–0.5	+7.0	V
$I_{IK}$	input diode current	$V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V; note 1	–	±20	mA
$I_{OK}$	output diode current	$V_O < -0.5$ V; note 1	–	–20	mA
$V_O$	output voltage	active mode; note 1	–0.5	$V_{CC} + 0.5$	V
		high-impedance mode; note 1	–0.5	7.0	V
$I_O$	output sink current	$-0.5$ V < $V_O$ < 7.0 V; note 1	–	25	mA
$I_{CC}, I_{GND}$	$V_{CC}$ or GND current	note 1	–	50	mA
$T_{stg}$	storage temperature		–65	+150	°C
$P_D$	power dissipation	$T_{amb} = -40$ to $+125$ °C; note 2	–	300	mW

## Notes

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. Above 110 °C the value of  $P_D$  derates linearly with 8 mW/K.

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## DC CHARACTERISTICS

## Type 74HC3G06

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note 1</b>							
V <sub>IH</sub>	HIGH-level input voltage		2.0	1.5	1.2	–	V
			4.5	3.15	2.4	–	V
			6.0	4.2	3.2	–	V
V <sub>IL</sub>	LOW-level input voltage		2.0	–	0.8	0.5	V
			4.5	–	2.1	1.35	V
			6.0	–	2.8	1.8	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 μA	2.0	–	0	0.1	V
		I <sub>O</sub> = 20 μA	4.5	–	0	0.1	V
		I <sub>O</sub> = 4.0 mA	4.5	–	0.15	0.33	V
		I <sub>O</sub> = 20 μA	6.0	–	0	0.1	V
		I <sub>O</sub> = 5.2 mA	6.0	–	0.16	0.33	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	6.0	–	–	±1.0	μA
I <sub>LO</sub>	output leakage current	V <sub>I</sub> = V <sub>IH</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND	6.0	–	–	±5.0	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	6.0	–	–	10	μA
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
V <sub>IH</sub>	HIGH-level input voltage		2.0	1.5	–	–	V
			4.5	3.15	–	–	V
			6.0	4.2	–	–	V
V <sub>IL</sub>	LOW-level input voltage		2.0	–	–	0.5	V
			4.5	–	–	1.35	V
			6.0	–	–	1.8	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 μA	2.0	–	–	0.1	V
		I <sub>O</sub> = 20 μA	4.5	–	–	0.1	V
		I <sub>O</sub> = 4.0 mA	4.5	–	–	0.4	V
		I <sub>O</sub> = 20 μA	6.0	–	–	0.1	V
		I <sub>O</sub> = 5.2 mA	6.0	–	–	0.4	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	6.0	–	–	±1.0	μA
I <sub>LO</sub>	output leakage current	V <sub>I</sub> = V <sub>IH</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND	6.0	–	–	±10	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	6.0	–	–	20	μA

## Note

1. All typical values are measured at T<sub>amb</sub> = 25 °C.

## Inverter with open-drain outputs

## 74HC3G06; 74HCT3G06

## Type 74HCT3G06

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note 1</b>							
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	1.6	–	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	–	1.2	0.8	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 μA	4.5	–	0	0.1	V
		I <sub>O</sub> = 4.0 mA	4.5	–	0.15	0.33	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5	–	–	±1.0	μA
I <sub>LO</sub>	output leakage current	V <sub>I</sub> = V <sub>IH</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND	5.5	–	–	±5.0	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	5.5	–	–	10	μA
ΔI <sub>CC</sub>	additional supply current per input	V <sub>I</sub> = V <sub>CC</sub> – 2.1 V; I <sub>O</sub> = 0	4.5 to 5.5	–	–	375	μA
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	–	–	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	–	–	0.8	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 μA	4.5	–	–	0.1	V
		I <sub>O</sub> = 4.0 mA	4.5	–	–	0.4	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5	–	–	±1.0	μA
I <sub>LO</sub>	output leakage current	V <sub>I</sub> = V <sub>IH</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND	5.5	–	–	±10	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	5.5	–	–	20	μA
ΔI <sub>CC</sub>	additional supply current per input	V <sub>I</sub> = V <sub>CC</sub> – 2.1 V; I <sub>O</sub> = 0	4.5 to 5.5	–	–	410	μA

## Note

1. All typical values are measured at T<sub>amb</sub> = 25 °C.

## Inverter with open-drain outputs

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## AC CHARACTERISTICS

## Type 74HC3G06

GND = 0 V;  $t_r = t_f \leq 6.0$  ns;  $C_L = 50$  pF.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note 1</b>							
t <sub>PZL</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	22	95	ns
			4.5	–	9	18	ns
			6.0	–	8	16	ns
t <sub>PLZ</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	24	95	ns
			4.5	–	11	20	ns
			6.0	–	10	19	ns
t <sub>THL</sub>	output transition time	see Figs 5 and 6	2.0	–	18	95	ns
			4.5	–	6	19	ns
			6.0	–	5	16	ns
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
t <sub>PZL</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	–	125	ns
			4.5	–	–	25	ns
			6.0	–	–	20	ns
t <sub>PLZ</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	–	125	ns
			4.5	–	–	27	ns
			6.0	–	–	23	ns
t <sub>THL</sub>	output transition time	see Figs 5 and 6	2.0	–	–	125	ns
			4.5	–	–	25	ns
			6.0	–	–	20	ns

## Note

1. All typical values are measured at T<sub>amb</sub> = 25 °C.



Inverter with open-drain outputs

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Type 74HCT3G06

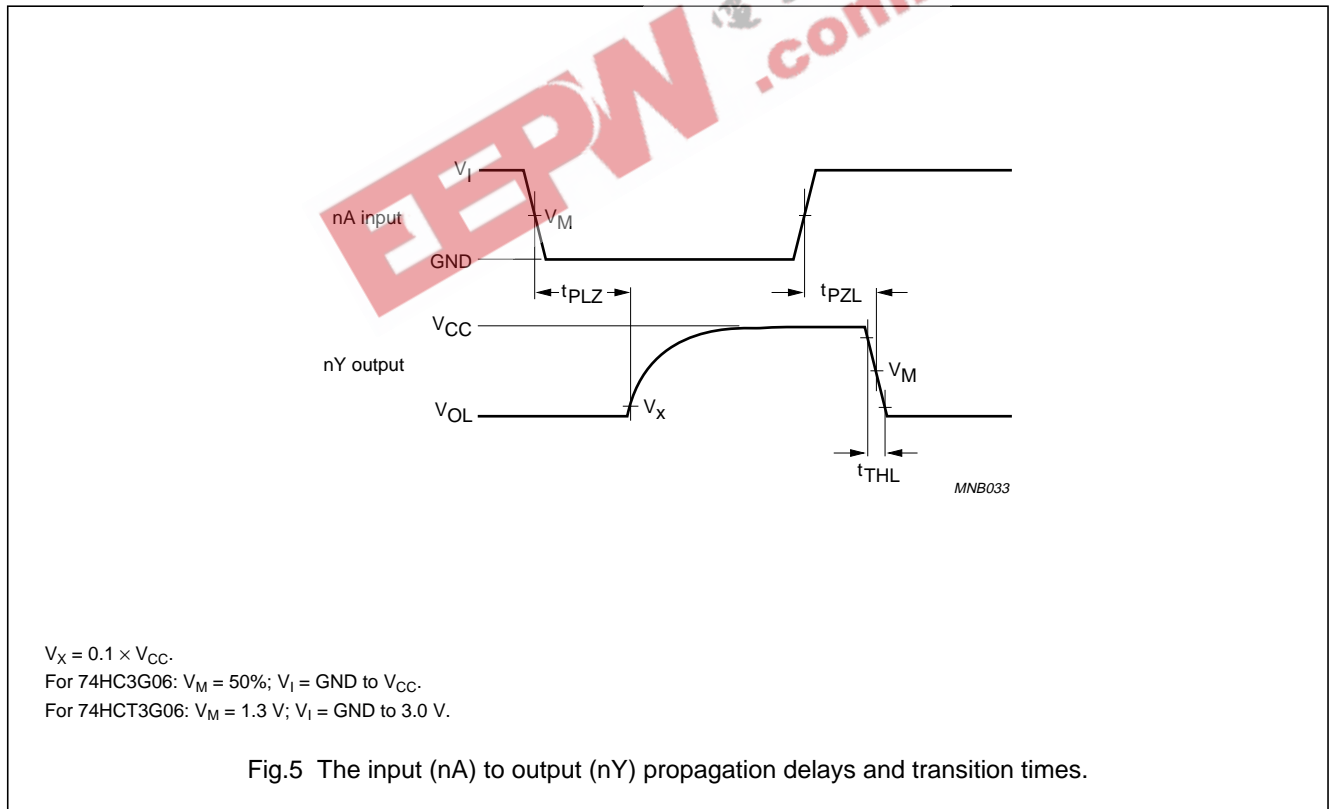
GND = 0 V;  $t_r = t_f \leq 6.0$  ns;  $C_L = 50$  pF.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +85 °C; note 1</b>							
t <sub>PZL</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	9	24	ns
t <sub>PLZ</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	12	27	ns
t <sub>THL</sub>	output transition time	see Figs 5 and 6	2.0	–	6	19	ns
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
t <sub>PZL</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	–	29	ns
t <sub>PLZ</sub>	propagation delay nA to nY	see Figs 5 and 6	2.0	–	–	32	ns
t <sub>THL</sub>	output transition time	see Figs 5 and 6	2.0	–	–	22	ns

Note

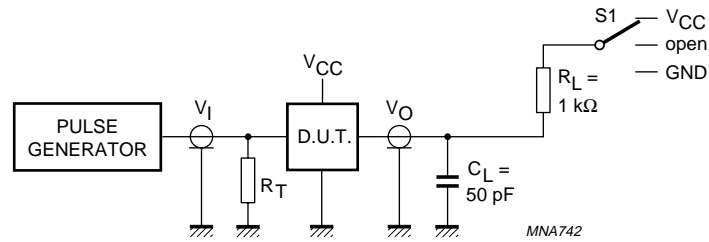
1. All typical values are measured at T<sub>amb</sub> = 25 °C.

AC WAVEFORMS



Inverter with open-drain outputs

74HC3G06; 74HCT3G06



TEST	S1
$t_{PLH}/t_{PHL}$	V <sub>CC</sub>
$t_{PLZ}/t_{PZL}$	V <sub>CC</sub>

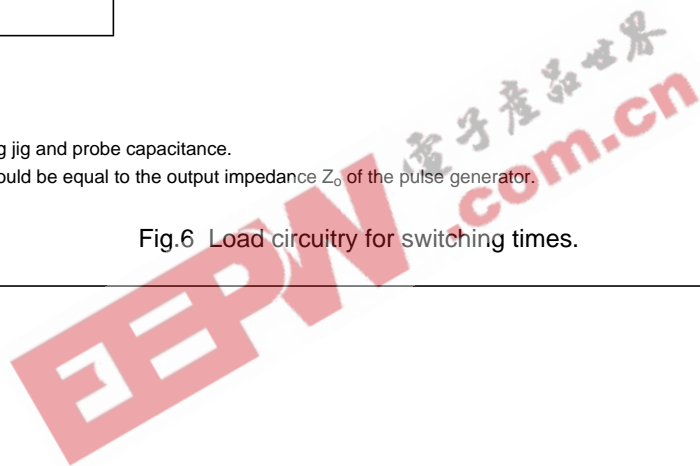
Definitions for test circuit:

R<sub>L</sub> = Load resistor.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

R<sub>T</sub> = Termination resistance should be equal to the output impedance Z<sub>o</sub> of the pulse generator.

Fig.6 Load circuitry for switching times.

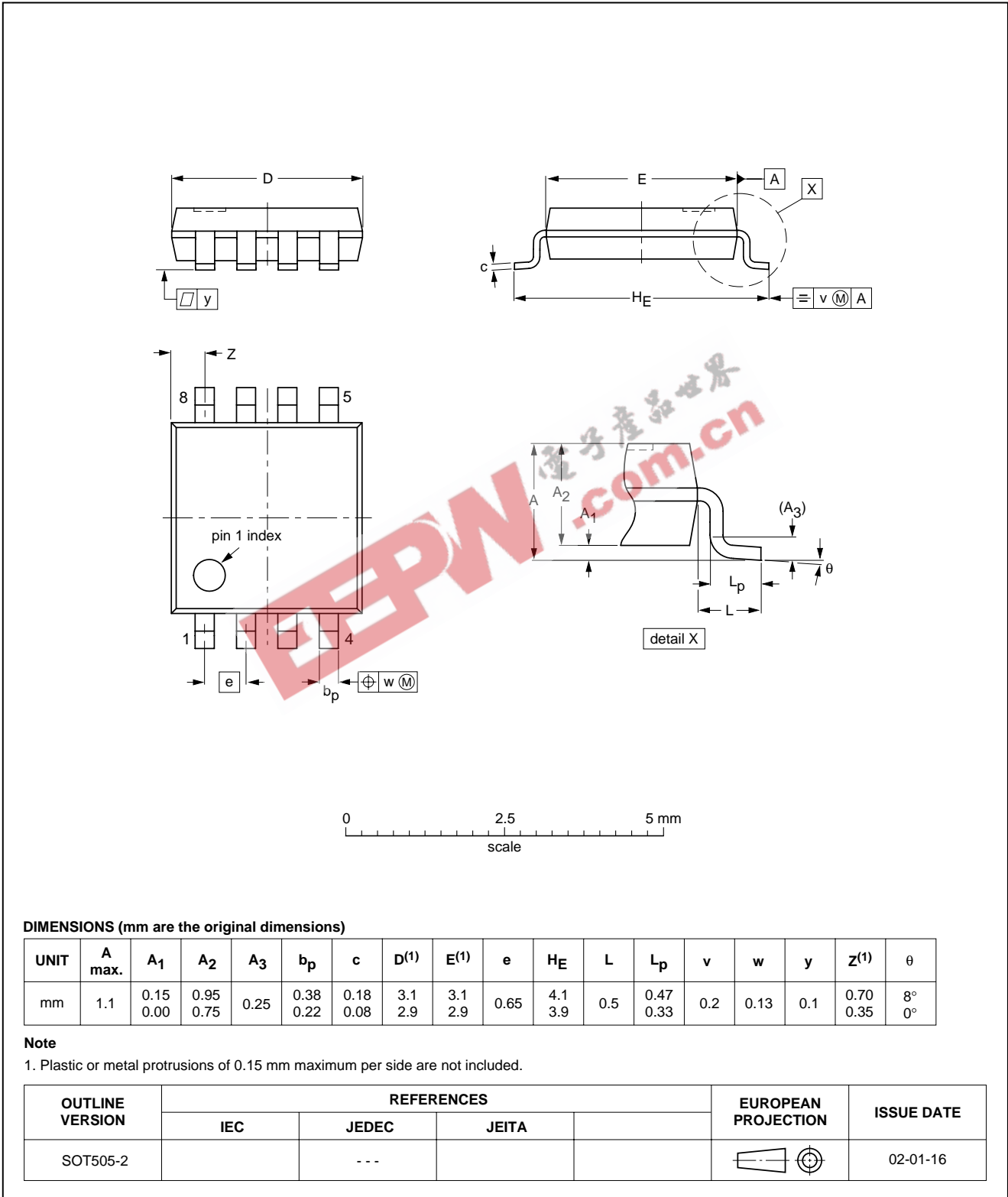


Inverter with open-drain outputs

74HC3G06; 74HCT3G06

PACKAGE OUTLINES

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

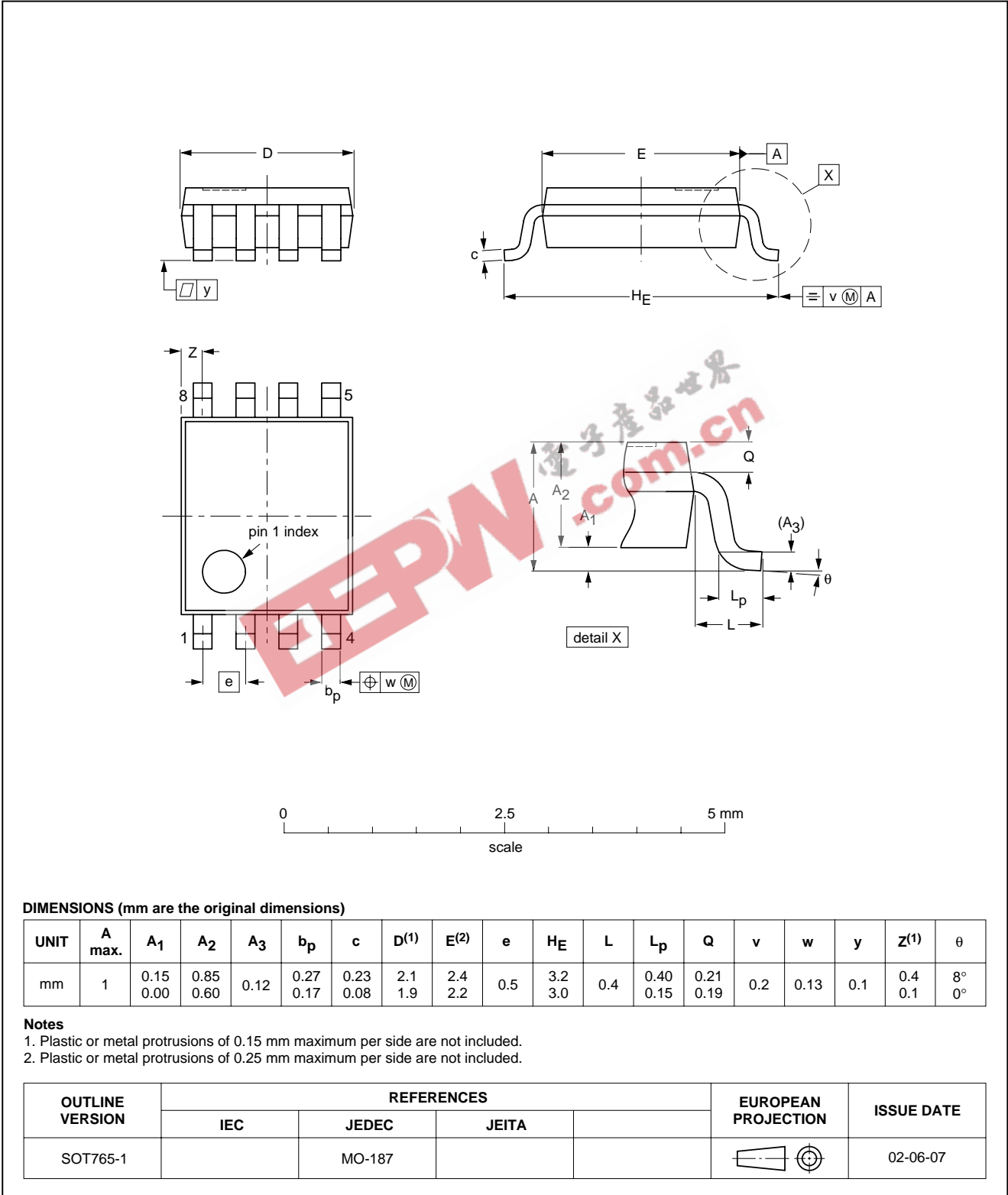


Inverter with open-drain outputs

74HC3G06; 74HCT3G06

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



## Inverter with open-drain outputs

## 74HC3G06; 74HCT3G06

## DATA SHEET STATUS

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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